Procedural Review Voting Sheet
2012 Cycle 5

REGION: Japan
COMMITTEE: Silicon Wafer
EVENT: SEMICON Japan 2012
DATE OF MEETING: Dec. 6, 2012
PLACE OF MEETING: Makuhari Messe, Chiba, Japan
COMMITTEE CO-CHAIRS: Naoyuki J. Kawai/The University of Tokyo, Tetsuya Nakai/SUMCO
SEMI STAFF: Hirofumi Kanno

A&R Voter: Name/Company
Date: 200X/MM/DD

I. Document Number & Title

Document	Document Title
5442	Reapproval of SEMI M74-1108, Specification for 450 mm Diameter Mechanical Handling Polished Wafers

II. Tally (Staff to fill in)

Voting Tally: As-cast tally after close of voting period

A minimum of 60% of the voting interests that have voting members within the technical committee must return votes. (Regulations ¶ 9.6.1)

	Return		Distribution		Return Rate	
Yellow	55	÷	91	=	60.4%	>=60%
Lilac & Others	8					

Total Vote	63					
Reject	0					
Accept	27					

A&R	Not approved
	Reason:

III. Rejects
IV. Comments
V. Summary of Editorial Changes
VI. Approval Conditions Check

APPROVAL CONDITION 1: All negatives have been discussed and were withdrawn, found not related, or not persuasive. (Regulations ¶ 9.6.2)

APPROVAL CONDITION 2: At least 90% of the sum of the valid accept and reject votes must be accept. (Regulations ¶ 9.6.3)

Note: if both approval conditions are not satisfied, the document fails.

		Accepts		(Accepts + Valid			
Approval Rate	=	27	/	27	=	100.0%	>=90%

A&R		Not approved
	Reason:	

VII. Safety Check

See § 14 of the Regulations for further information

Motion:	X	This is not a Safety Document: when all safety-related information is removed, the document is still technically sound and complete.
		This is a Safety Document: when all safety-related information is removed, the document is not technically sound and complete.
		Safety Checklist (Regulations ¶ 14.3) is complete and has been included with the document throughout the balloting process.
Motion by/2nd by		Mike Goldstein (Intel)/ Friedrich Passek (Siltronic)
Discussion		None
Vote		10-0 Motion passed
A&R		Not approved
	Reason:	

VIII. Intellectual Property Check

Note: This ballot may be all or part of a Standard or Safety Guideline. This IP check applies to the entire Standard or Safety Guideline. See § 15 of the Regulations for further information

X	The meeting chair asked those present in person or by electronic link, if they were aware of any potentially material patented technology or copyrighted items* in the Standard or Guideline.			
	X	No potentially material patented technology or copyrighted items are known		**GO TO SECTION IX**
		Potentially material patented technology or copyrighted items are known but a Letter of Assurance (LOA) or copyright release for such material has been obtained or presented to the committee.		**GO TO SECTION IX**
		Potentially material patented technology or copyrighted items are known but an LOA or copyright release for some of the material(s) has NOT been obtained or presented to the committee		
	MOTION		Ask ISC for special permission to publish	
			Quit activity	
			Wait for LOA for patented technology or release of copyrighted items.	
	Motion by/2nd by		Name (Company)/Name (Company)	
	Discussion		XXXX	
	Vote		XX-XX	
	Final Action		Motion Passed	
			Motion Failed	
A&R		**Not approved**		
		Reason:		

* Note: Such potentially material patented technology or copyrighted items might have become known since the Standard or Safety Guideline was last reviewed, or might become relevant due to this ballot.

IX. Action for this document

Motion	X	This document passed committee review as balloted and will be forwarded to the A&R for procedural review.
		This document passed committee review with editorial changes and will be forwarded to the A&R for procedural review.
		This document failed committee review and will be returned to the task force for rework.
		This document failed committee review and work will be discontinued.
Motion by/2nd by		Friedrich Passek (Siltronic)/ Mike Goldstein (Intel)
Discussion		None
Vote		10-0
Final Action	X	Motion passed
		Motion failed
A&R		**Approved**
		Not approved
	Reason:	